

# **Two-dimensional PSD**

S5990-01, S5991-01

## Improved tetra-lateral type for surface mounting

#### Features

- ► Large photosensitive area S5990-01: 4 × 4 mm S5991-01: 9 × 9 mm
- Chip carrier package for surface mounting (automatic mounting with solder reflow) Thin package: 1.26 mmt
- Improved tetra-lateral type (pin-cushion type) delivers superior position detection.
- Evaluation circuit board provided (sold separately) C4674-01 (DC signal processing circuit)

#### - Applications

- → Light spot detection
- → Pointing device (computer mouse, track-ball)
- Position measurement

### **➡** Absolute maximum ratings (Ta=25 °C)

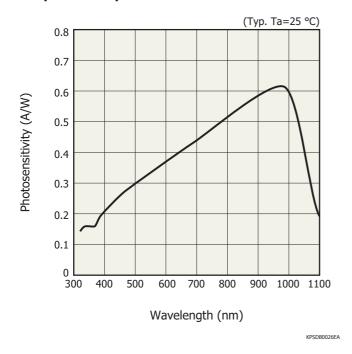
Parameter	Symbol	Value	Unit
Reverse voltage	VR max	20	V
Operating temperature	Topr	-20 to +60	°C
Storage temperature	Tstg	-20 to +80	°C

#### **➡** Electrical and optical characteristics (Ta=25 °C)

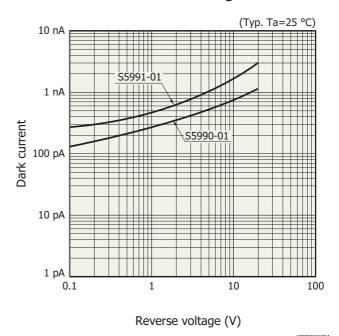
Parameter	Symbol	Condition	S5990-01			S5991-01			Linit
			Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
Spectral response range	λ		-	320 to 1100	-	-	320 to 1100	-	nm
Peak sensitivity wavelength	λр		-	960	-	-	960	-	nm
Photosensitivity	S	λ=λρ	-	0.6	-	-	0.6	-	A/W
Interelectrode resistance	Rie	Vb=0.1 V	5	7	15	5	7	15	kΩ
Position detection error	E	$\lambda$ =900 nm, VR=5 V light spot size: $\phi$ 0.2 mm *	-	±70	±150	-	±150	±250	μm
Saturation photocurrent	Ist	$\lambda$ =900 nm, VR=5 V RL=1 k $\Omega$	-	500	-	-	500	-	μΑ
Dark current	ID	VR=5 V	-	0.5	10	-	1	50	nA
Rise time	tr	VR=5 V, RL=1 kΩ $\lambda$ =900 nm	-	1	-	-	2	-	μs
Terminal capacitance	Ct	VR=5 V, f=10 kHz	-	150	300	-	500	1000	pF
Position resolution	ΔR	Io=1 μA, B=1 kHz *	-	0.7	-	-	1.5	-	μm

<sup>\*</sup> In the range that is 80% from the center to the edge. Recommended light spot size is larger than φ0.2 mm.

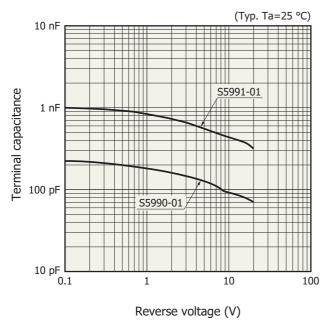
### Spectral response



### **→** Dark current vs. reverse voltage



### Terminal capacitance vs. reverse voltage



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### **Example of position detectability (Ta=25 °C,** $\lambda$ =830 nm, light spot size: $\phi$ 0.2 mm)

S5990-01

(Scan interval: 0.4 mm)

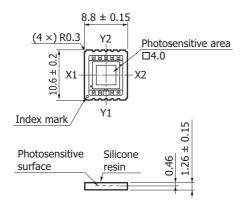
(Scan interval: 1 mm)

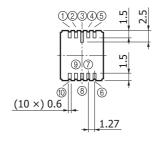
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### Dimensional outlines (unit: mm)

#### S5990-01





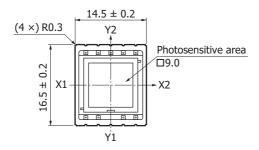
Burrs shall protrude no more than 0.3 mm on any side of package.

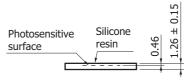
- ① Anode X1 (I1) ② NC
- ③ NC
- 4 NC
- ⑤ Anode Y1 (I3)
- 6 Anode X2 (I2)
- ⑦ NC
- ® Cathode
- 9 NC
- Anode Y2 (I4)

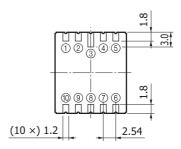
3 pin should be open-circuited

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#### S5991-01







Burrs shall protrude no more than 0.3 mm on any side of package.

- ① Anode X1 (I1)
- ② NC
- ③ NC
- ④ NC
- ⑤ Anode Y1 (I3)
- 6 Anode X2 (I2)
- ⑦ NC
- ® Cathode 9 NC
- Anode Y2 (I4)
- ③ pin should be open-circuited

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#### - Conversion formula

$$\frac{(l_2 + l_3) - (l_1 + l_4)}{l_1 + l_2 + l_3 + l_4} = \frac{2x}{L}$$

$$\frac{(l_2 + l_4) - (l_1 + l_3)}{l_1 + l_2 + l_3 + l_4} = \frac{2y}{L}$$

x, y: position coordinate of light spot

S5990-01: L=4.5 mm S5991-01: L=10 mm

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#### Precautions

- The light input window of this product uses soft silicone resin. Avoid touching the window to keep it from grime and damage that can decrease sensitivity. External force applied to the resin surface may deform or cut off the wires, so do not touch the window to prevent such troubles.
- · Use rosin flux when soldering, to prevent the terminal lead corrosion. Reflow oven temperature should be at 260 °C maximum for 5 seconds maximum time under the conditions that no moisture absorption occurs.
- Reflow soldering conditions differ depending on the type of PC board and reflow oven. Carefully check these conditions before use.
- · Silicone resin swells when it absorbs organic solvent, so do not use any solvent other than alcohol.
- · Avoid unpacking until you actually use this product to prevent the terminals from oxidation and dust deposits or the coated resin from absorbing moisture.
- When the product is stored for 3 months while not unpacked or 24 hours have elapsed after unpacking, perform baking in nitrogen atmosphere at 150 °C for 3 to 5 hours or at 120 °C for 12 to 15 hours before use.

Information described in this material is current as of May, 2013.

Product specifications are subject to change without prior notice due to improvements or other reasons. This document has been carefully prepared and the information contained is believed to be accurate. In rare cases, however, there may be inaccuracies such as text errors. Before using these products, always contact us for the delivery specification sheet to check the latest specifications.

The product warranty is valid for one year after delivery and is limited to product repair or replacement for defects discovered and reported to us within that one year period. However, even if within the warranty period we accept absolutely no liability for any loss caused by natural disasters or improper product use.

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